

World Components Network Service Ltd**Customer Name:****Date:**

2016-2-23

Part No:

WCN2S-1028B7-A1

**Product Group
Description:**

LED Display

Customer Part No:**Approval Date:****Customer
Confirmation****Approved by****Checked by**Athena
2016-2-23**Prepared By**Fei
2016-2-23

Country of Origin: China

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Table of Contents

NO.	ITEM	PAGE
1	Cover	1
2	Table of Contents	2
3	Revision Record	3
4	Description	4
5	Outer Dimension and Circuit Diagram	5
6	Absolute Maximum Rating and Electrical/Optical Characteristics Rating	6
7	Typical Electrical/ Optical Characteristic Curves and Spectrometer	7
8	Packaging Data	8
9	Moisture Proof Packaging	9

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REVISION RECORD

MARKER	Matter for revision	SHEET	DTAE	MAKER	APPOVED SIGN	
	Reason for revision					
A0	<p style="margin: 0;">P# WCN2S-1028B7-A1</p> <hr style="border-top: 1px dashed black;"/> <p style="margin: 0;">New Version issued</p>	Whole Spec	2016-2- 23	Fei	Athena	

1. Type No./Manufacture's Name

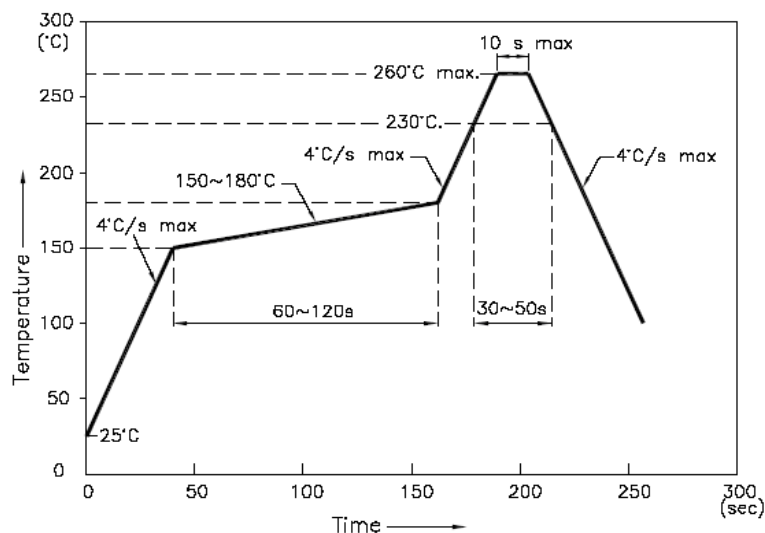
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2. Features:

- High Reliability
- Low Power Requirement
- Easy Assembly

3. Faction: Display Digit Characteristic**4. Soldering Conditions: Soldering Temp. 260 ± 5 °C, Soldering Time. 3~5 sec.**

Soldering Power <30 W.

5. Re-flow Temp/Time**NOTES:**

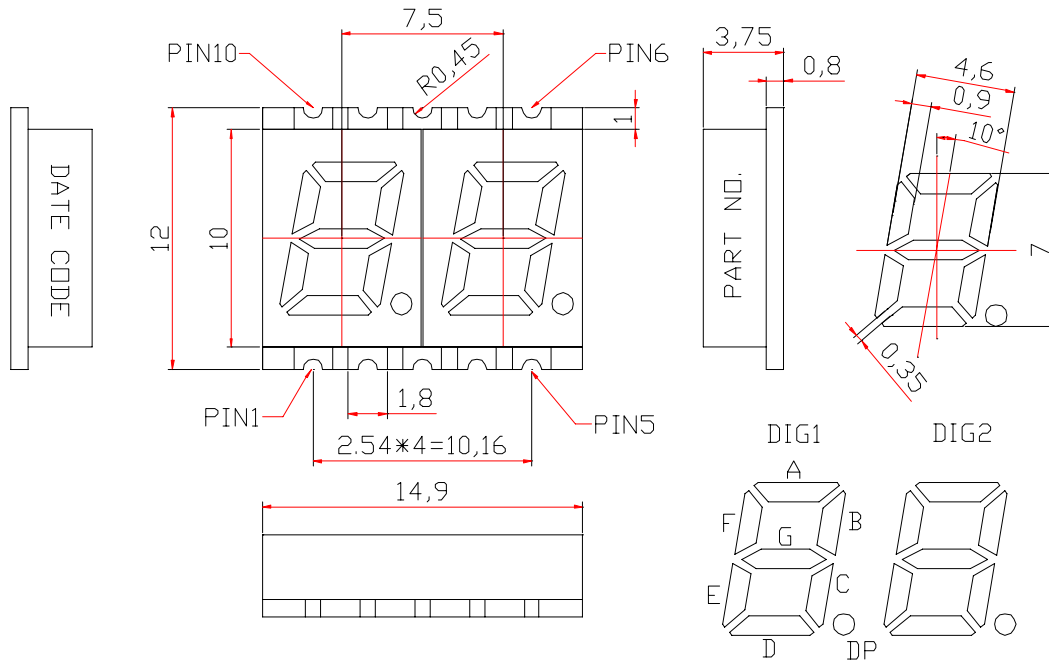
5.1. We recommend the re-flow temperature $245^{\circ}\text{C} (\pm 5^{\circ}\text{C})$. the maximum soldering temperature should be limited to 260°C .

5.2. Don't cause stress to the epoxy resin while it is exposed to high temperature. Number of re-flow process shall be 2 times or less.

6. Description:

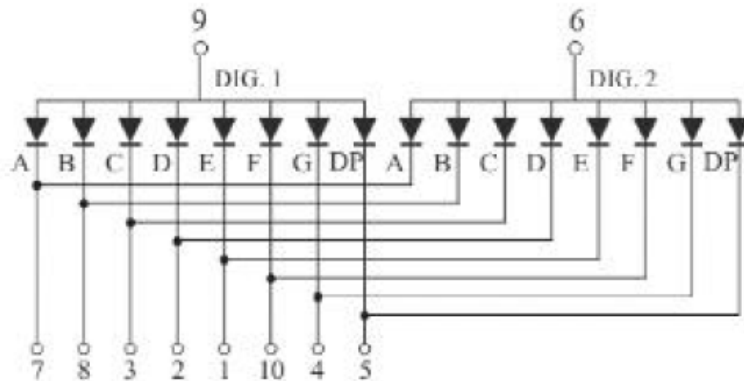
- Two Digit LED Display
- Digit Height: 7.0mm (0.28")
- Gray Face and Milky Segment
- Color: Blue

Outer Dimension:



Notes: Unless otherwise stated, the tolerance is $\pm 0.25\text{mm}$.

Circuit Diagram:



Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode E	6	Common Anode
2	Cathode D	7	Cathode A
3	Cathode C	8	Cathode B
4	Cathode G	9	Common Anode
5	Cathode DP	10	Cathode F

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■ ABSOLUTE MAXIMUM RATINGS AT TA=25°C

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P _a	—	Blue	92.5	mW
Forward Current Per Segment	I _F	—	Blue	25	mA
Peak Forward Current Per Segment	I _{FP}	1/10 Duty 1KHz	Blue	100	mA
Reverse Voltage Per Segment	V _R	—	Blue	5	V
Operating Temperature Range	Topr	—	—	-40~+105	°C
Storage Temperature Range	Tstg	—	—	-40~+105	°C

■ Electrical/Optical Characteristics Rating(Ta=25°C)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V _F	I _F =20mA	Per Chip	2.6	3.2	3.7	V
Reverse Current	I _R	V _R =5V	Per Chip	—	—	100	μA
Luminous Intensity	I _V	I _F =10mA	Per Chip	4001	6500	10500	ucd
Wave Length	λ _P	I _F =20mA	Per Chip	—	460	—	nm
	λ _D			465	470	475	
Luminous Intensity Matching Ratio (Segment To Segment)	I _{v-m}	I _F =10mA				1.2:1	

■ Luminous Intensity Sorting: (Luminous intensity tolerance :+/-10%)

Rank	Symbol	Condition	Min	Max	Unit
L	L	I _F =10mA	4001	5000	ucd
M	M	I _F =10mA	5001	6100	μcd
N	N	I _F =10mA	6101	7200	μcd
O	O	I _F =10mA	7201	8500	μcd
P	P	I _F =10mA	8501	10500	μcd

■ **Typical Optical-Electronic Characteristic Curves**

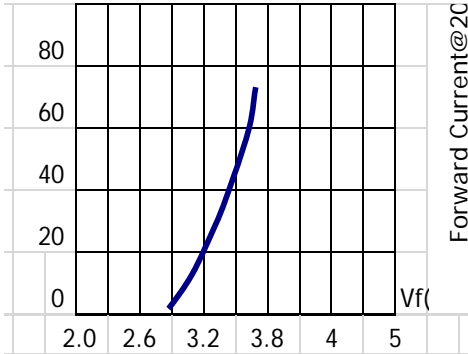


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

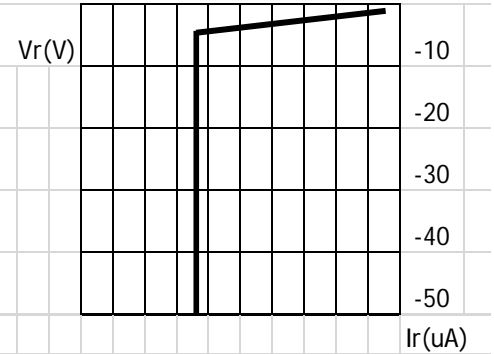
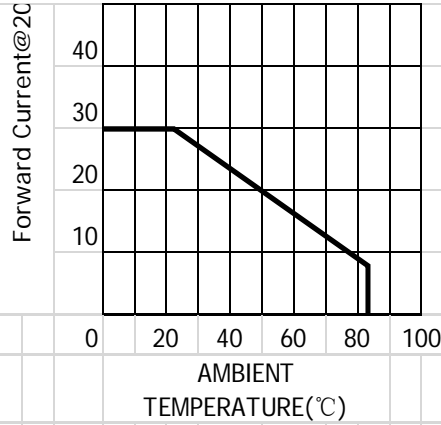


Fig.2 REVERSE CURRENT VS. REVERSE VOLTAGE.

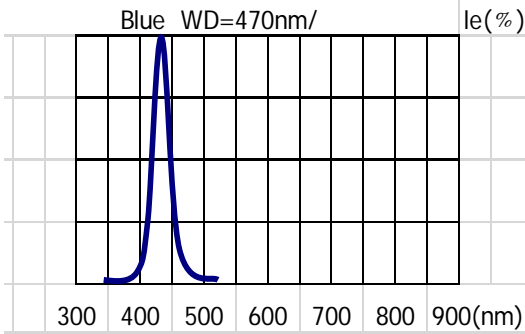
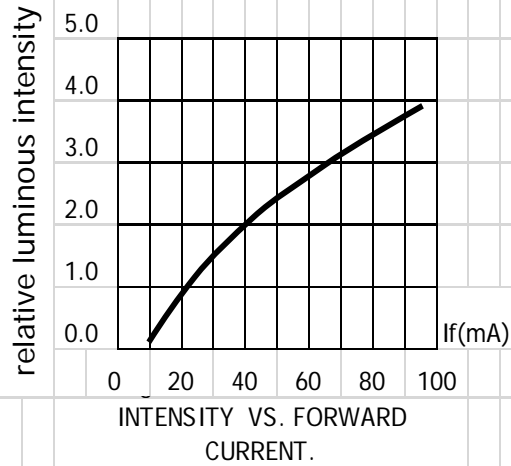
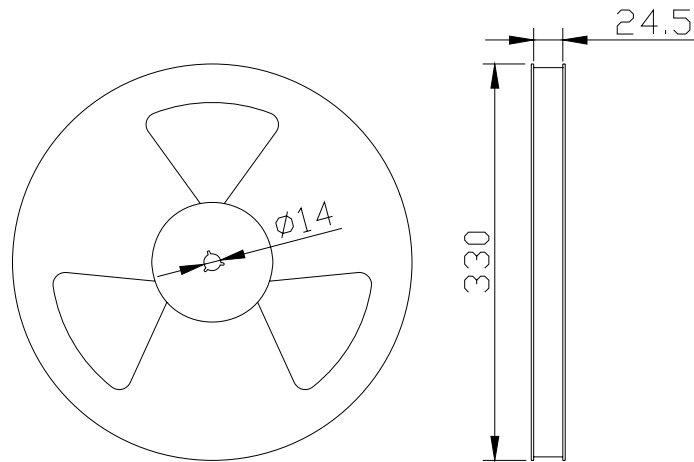


Fig.4 RELATIVE LUMINOUS INTENSITY VS. WAVELENGTH.

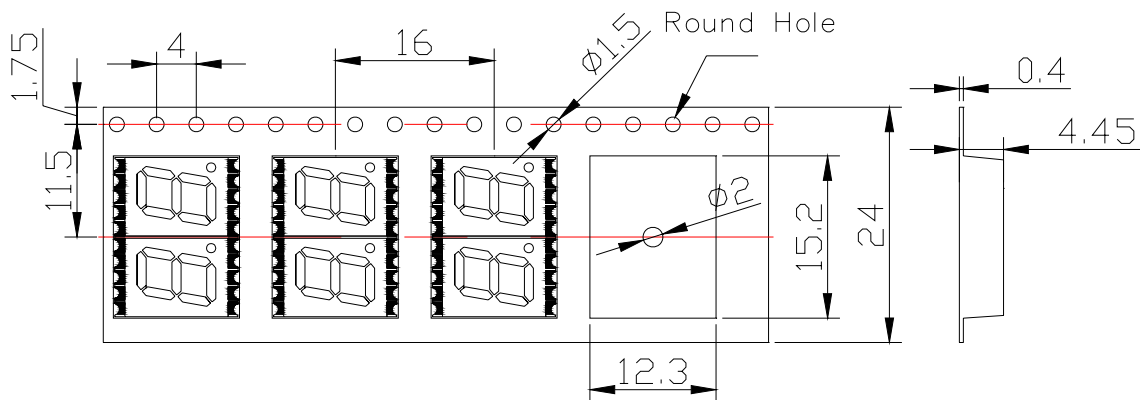


INTENSITY VS. FORWARD CURRENT.

■ Packing Reel Dimensions(mm):

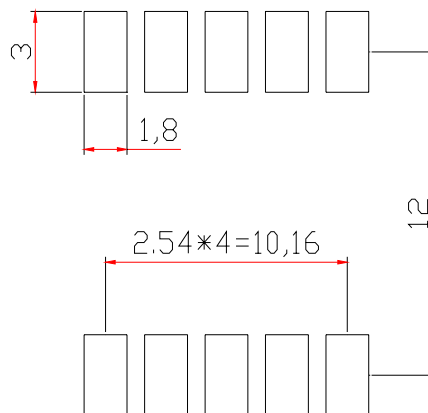


■ Dimensions of Tape (Unit: mm)



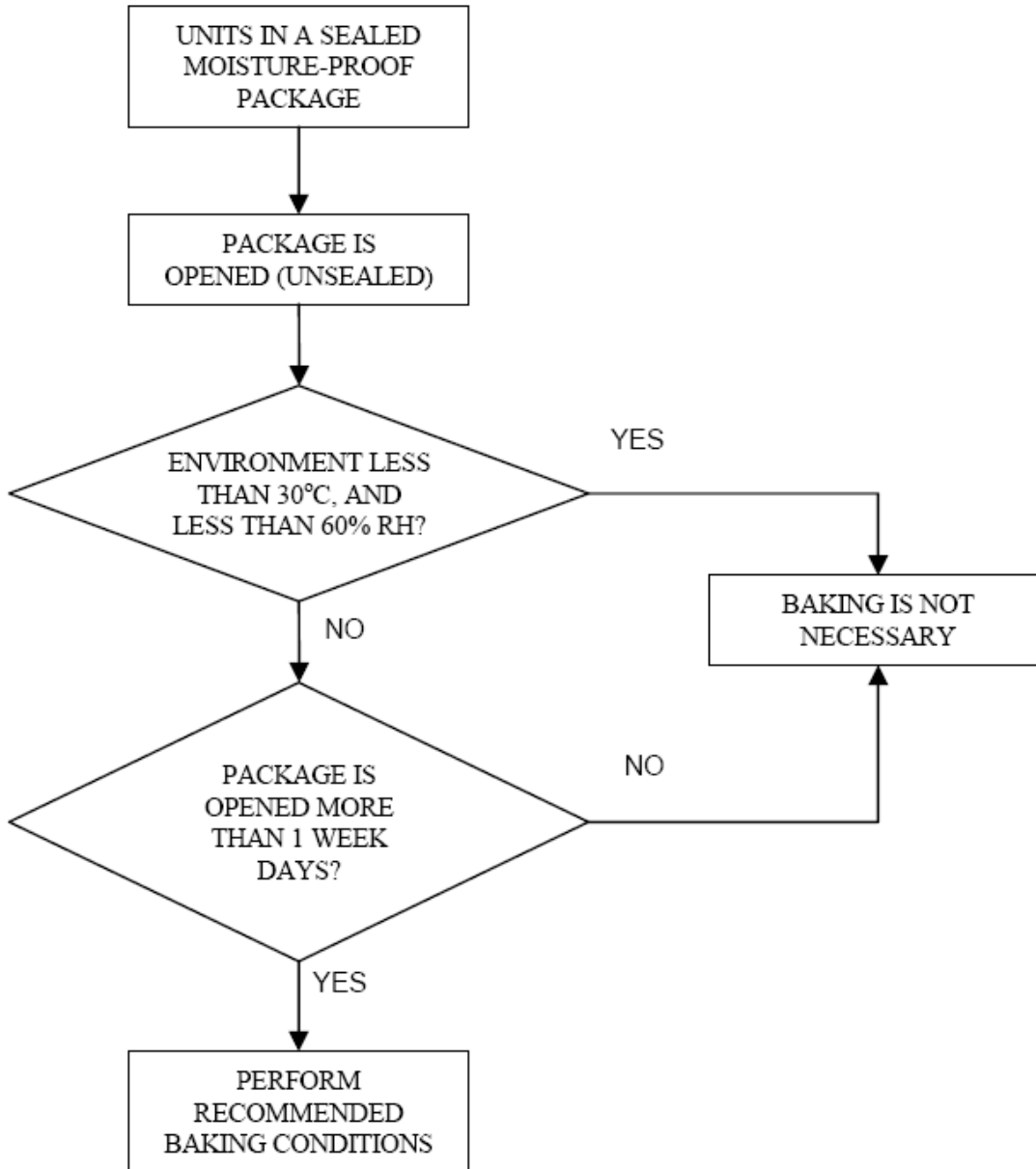
■ One Reel contained 900 PCS products:

■ Recommended Soldering Pattern:



■ **Moisture Proof Packaging:**

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 60% RH or less. Once the package opened, moisture absorption begins.



■ **Baking Conditions:**

If the parts not stored in dry conditions, they must be baked before re-flow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60 °C	≥ 48hours
In Bulk	100 °C	≥ 4hours
	125 °C	≥ 2hours

■ **Baking should only be done once.**